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FUJIT.080

8. (Previously Presented) A light-emitting diode according to claim 6, wherein a metal

layer which reflects light to the luminous extracting side of said device is formed on said

reflection plane.

9. (Previously Presented) A light-emitting diode according to claim 6, wherein said

crystal growth substrate is formed by using $Al_xGa_{1-x}N$ ($0 \le x \le 1$) or silicon carbide (SiC).

10. (Currently Amended) A light-emitting diode according to claim 6, wherein a taper

plane which inclines to said crystal growth plane of said crystal growth substrate is

formed at least as a portion of at least one of said output plane or at least as a portion of

said reflection plane.

11. (Canceled)

12. (Canceled)

13. (Canceled)

14. (Canceled)

15. (Canceled)

16. (Canceled)

17. (Canceled)

18. (Canceled)

19. (Canceled)

20. (Canceled)